

**AEC-Q101 Qualified** 

# 10V Drive Nch MOSFET

### RSJ400N06FRA

### Structure

Silicon N-channel MOSFET

### Features

- 1) Low on-resistance.
- 2) High current
- 3) High power Package

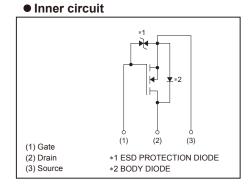
### Application

Switching

### Packaging specifications

	Package	Taping
Type	Code	TL
	Basic ordering unit (pieces)	1000
RSJ400N06F	0	

Dimensions (Unit : mm)



### ●Absolute maximum ratings (T<sub>a</sub> = 25°C)

Paramet	Symbol	Limits	Unit	
Drain-source voltage	$V_{DSS}$	60	V	
Gate-source voltage	$V_{GSS}$	±20	V	
Drain current	Continuous	$I_D$	±40	Α
Drain current	Pulsed	I <sub>DP</sub> *1	±80	Α
Source current	Continuous	I <sub>S</sub>	40	Α
(Body Diode)	Pulsed	I <sub>SP</sub> *1	80	Α
Power dissipation		P <sub>D</sub> *2	50	W
Channel temperature	Tch	150	°C	
Range of storage temp	Tstg	-55 to +150	°C	

<sup>\*1</sup> Pw≤10µs, Duty cycle≤1%

### • Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to Case	R <sub>th (ch-c)</sub> *	2.5	°C/W

<sup>\*</sup> T<sub>c</sub>=25°C

<sup>\*2</sup> T<sub>c</sub>=25°C

### ●Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I <sub>GSS</sub>	-	-	±10	μA	$V_{GS}=\pm20V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	60	1	1	٧	$I_D=1$ mA, $V_{GS}=0$ V
Zero gate voltage drain current	I <sub>DSS</sub>	1	ı	1	μA	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	1.0	1	3.0	٧	$V_{DS}=10V$ , $I_{D}=1mA$
Static drain-source on-state resistance	R <sub>DS (on)</sub>	-	11	16	mΩ	I <sub>D</sub> =40A, V <sub>GS</sub> =10V
Forward transfer admittance	IY <sub>fs</sub> I*	14	1	1	S	$I_{D}=20A, V_{DS}=10V$
Input capacitance	C <sub>iss</sub>	-	2400	1	рF	V <sub>DS</sub> =10V
Output capacitance	C <sub>oss</sub>	1	490	-	рF	V <sub>GS</sub> =0V
Reverse transfer capacitance	$C_{rss}$	1	250	-	рF	f=1MHz
Turn-on delay time	t <sub>d(on)</sub> *	1	20	-	ns	I <sub>D</sub> =20A, V <sub>DD</sub> ≒ 30V
Rise time	t <sub>r</sub> *	1	60	-	ns	V <sub>GS</sub> =10V
Turn-off delay time	t <sub>d(off)</sub> *	1	90	-	ns	$R_L=1.5\Omega$
Fall time	t <sub>f</sub> *	1	140	-	ns	$R_G=10\Omega$
Total gate charge	Q <sub>g</sub> *	-	52	-	nC	V <sub>DD</sub> ≒ 30V
Gate-source charge	Q <sub>gs</sub> *	-	8	-	nC	I <sub>D</sub> =40A,
Gate-drain charge	Q <sub>gd</sub> *	-	15	-	nC	V <sub>GS</sub> =10V

<sup>\*</sup>Pulsed

### •Body diode characteristics (Source-Drain) ( $T_a = 25$ °C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward Voltage	V <sub>SD</sub> *	-	-	1.2	V	I <sub>s</sub> =40A, V <sub>GS</sub> =0V

<sup>\*</sup>Pulsed

### ●Electrical characteristic curves (Ta=25°C)

Fig.1 Static Drain-Source On-State Resistance vs. Drain Current

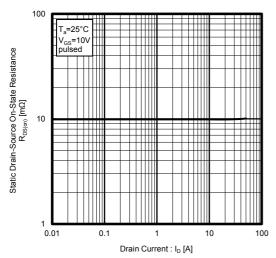


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

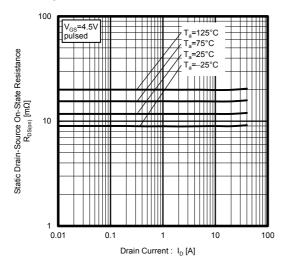


Fig.5 Forward Transfer Admittance vs. Drain Current

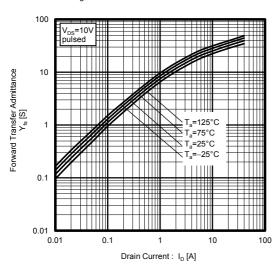


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current

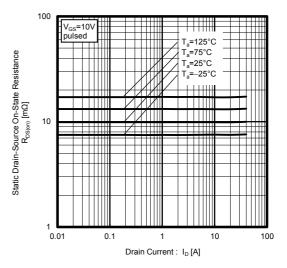


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current

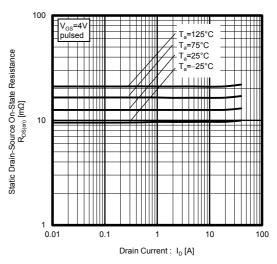
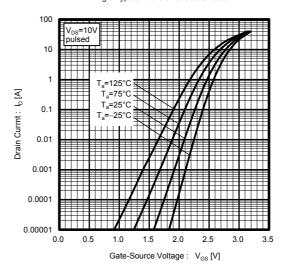
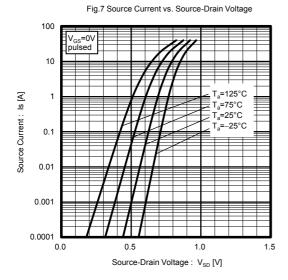
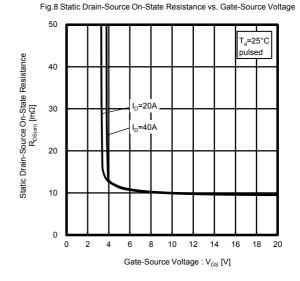
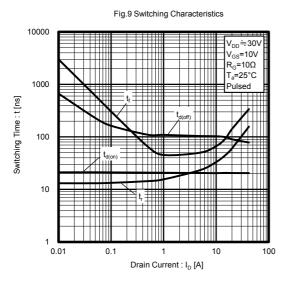


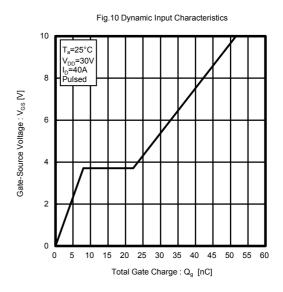
Fig.6 Typical Transfer Characteristics

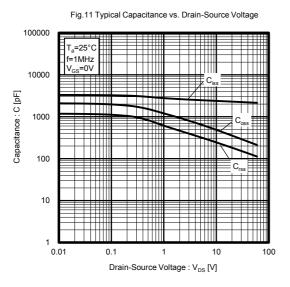




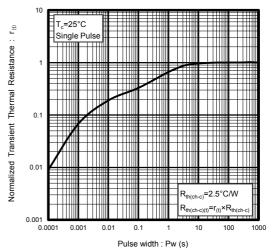












### Measurement circuits

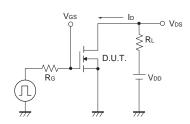


Fig.1-1 Switching Time Measurement Circuit

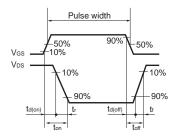


Fig.1-2 Switching Waveforms

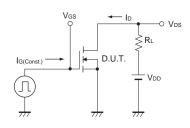


Fig.2-1 Gate Charge Measurement Circuit

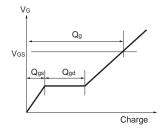


Fig.2-2 Gate Charge Waveform

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(Note1) Medical Equipment Classification of the Specific Applications

(140te 1) Medical Equipment Classification of the Opening Applications						
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CLASSⅢ	CLASSⅢ	CLASSIIb	CLASSIII			
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII			

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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
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  - [h] Use of the Products in places subject to dew condensation
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
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